

MPVM03N60 Intelligent Power Module

Features

- Integrated 6 fast recovery power MOSFETs (600V/3A)
- Integrated high voltage gate drive circuit (HVIC)
- Compatible with 3.3V & 5V input signal, effective at high level
- Insulation class 1500Vrms / min
- Integrated bootstrap functionality
- High reliability and thermal stability, good parameter consistency
- Integrated temperature output

Product Name	Marking	Package Type
MPVM03N60TA	MPVM03N60TA	DIP-23H
MPVM03N60TD	MPVM03N60TD	SOP-23H

Applications

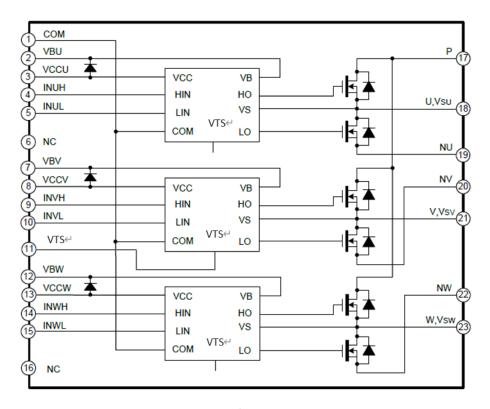
- Frequency conversion fans
- Cooker hood
- Air conditioning compressor
- Dish washer
- Air cleaner





SOP-23H

Internal Electrical Schematic



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit	
DC link supply voltage of P-N	V _{PN}	600	V	
Single MOSFET output current, T _C =25℃	<i>I</i> _{D25}	3.0	Δ.	
Single MOSFET output current, T _C =80 ℃	<i>I</i> _{D80}	2.5	Α	
Single MOSFET peak output current $T_C {=} 25 ^{\circ}\mathrm{C}$, pulse width ${<} 100 \mu s$	I DP	5	Α	
Power dissipation per MOSFET, T _C =25°C	PD	13.9	W	
Module supply voltage	Vcc	25	V	
High side floating supply voltage (V _B reference to V _S)	V _{BS}	20	V	
Input voltage	Vin	-0.3~VCC+0.3	V	
Operating junction temperature	TJ	-55 to 150	°C	
Operating case temperature, TJ≤150°C	Tc	-55 to 150	C	
Storage temperature range	Тѕтс	-55 to 150	$^{\circ}$	
Single MOSFET thermal resistance, junction-case	Rejc	9	°C/W	
Isolation test voltage (1min, RMS, f = 60Hz)	V _{ISO}	1500	Vrms	
Bootstrap diode forward current,T _C =25℃	lF	1	Α	
Bootstrap diode peak forward current, $T_{\text{C}}\text{=}25^{\circ}\!$	lfp	3	Α	

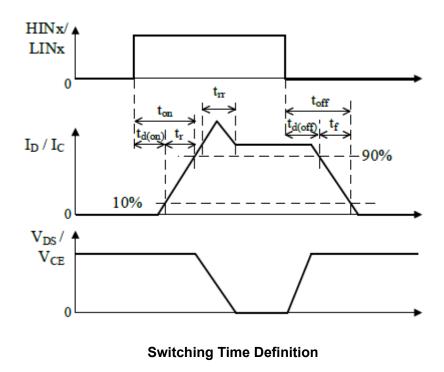
Recommended Operation Conditions

Doromotor	Cumbal		l lmi4		
Parameter	Symbol	Min.	Тур.	Max.	Unit
DC link supply voltage of P-N	VPN	-	300-	400	V
Low side supply voltage	VCC	13.5	15	16.5	V
High side floating supply voltage	VBS	13.5	15	16.5	V
Logic "1" input voltage (LIN, HIN)	VIN(ON)	2.5	-	-	V
Logic "0" input voltage (LIN, HIN)	VIN(OFF)	-	-	0.8	V
External deadtime between HIN and LIN	Tdead	-	540	-	ns
PWM switching frequency, TJ≤150°C	fPWM	-	16	-	KHz

Electrical Characteristics (unless otherwise noted, T_j =25 $^{\circ}$ C, V_{CC} = V_{BS} =15V)

Inverter Section

Downwater	Symbol Condition —		Value			Unit
Parameter			Min.	Тур.	Max.	Oilit
Drain-Source blocking voltage	B _{VDSS}	VIN=0V, ID=250uA	600	-	-	V
Drain-Source leakage current	I _{DSS}	VDS=600V, VGS=0V	-	-	1	uA
Drain-Source on-state resistance	R _{DS(on)}	VGS=10V, ID=1.5A	-	2.8	3.4	Ω
Diode forward voltage	V _{SD}	VSG=0V, Is=1.5A	-	-	1.4	V
	ton		-	820	-	ns
	toff	VPN=300V,	-	500	-	ns
Switching time	t _{rr}	VCC=VBS=15V ID=0.5A, VIN=0V~5V,	-	75	-	ns
	Eon	Inductive load	-	75	-	uJ
	Eoff		-	8	-	uJ



Control Section

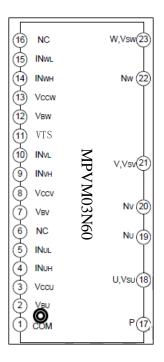
Parameter	Symb	Condition	Value			Uni
raiailletei	ol				t	
Quiescent VCC supply current	Iqcc	VBIAS (VCC, VBS) =15V	-	160	-	
Quiescent VB supply current	I _{QBS}	TA = 25°C	-	70	120	μA

			ase HVIC ature @25℃	600	790	980	mV
Temperature output voltage	VTS	V phase HVIC temperature @100℃		2.0	2.25	2.5	V
Low side undervoltage protection	UVccr	Reset level		8	8.9	9.8	V
High side undervoltage protection	UV _{BSR}	Reset level		8	8.9	9.8	V
Logic "1" input voltage (LIN, HIN)	ViH	Logic high level	Between input	2.5	-	-	V
Logic "0" input voltage (LIN, HIN)	VIL	Logic low level	and COM	-	-	0.8	V
Input high current for LIN LIIN	I _{IH}	VIN=5V	Between input	-	6	15	
Input bias current for LIN, HIN	I _{IL}	VIN=0V	and COM	-	-	1	μA

Bootstrap diode section

Davameter	Symbol	condition		Unit			
Parameter	Symbol condition -		Min.	Тур.	Max.	Oilit	
Forward voltage	VF	I _F =1A@ T _j =25℃	-	1.35	1.8		
		I _F =1A@ T _j =125℃	-	-	1.6	V	
Reverse recovery time	t _{rr}	I _F =1A, V _R =30V, di _F /dt=-200A/µs	-	-	45	ns	

Pin Assignment



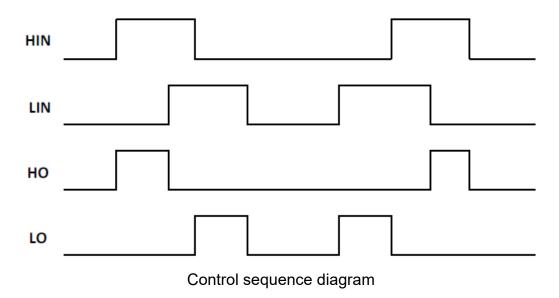
Pin Description

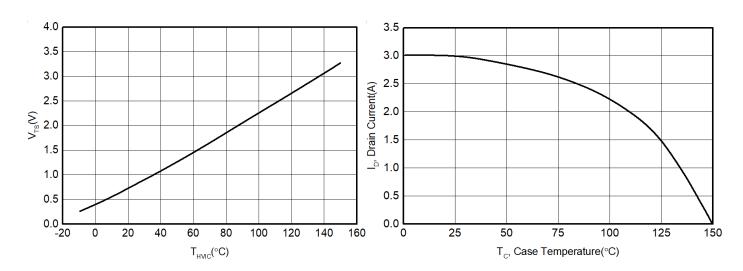
Pili Description	Γ.,		D. D. 1.11
Pin Number	Pin name	I/O	Pin Description
1	СОМ	I/O	Module common ground
2	V _{BU}	I/O	U-phase high side floating IC supply voltage
3	Vccu	I/O	U-phase low side driver supply voltage
4	Іпин	1	U-phase high side gate driver input
5	INUL	1	U-phase low side gate driver input
6	NC	I/O	No Connection
7	V_{BV}	I/O	V-phase high side floating IC supply voltage
8	Vccv	I/O	V-phase low side driver supply voltage
9	I _{NVH}	I	V-phase high side gate driver input
10	I _{NVL}	I	V-phase low side gate driver input
11	VTS	0	Temperature sensing output signal
12	V _{BW}	I/O	W-phase high side floating IC supply voltage
13	Vccw	I/O	W-phase low side driver supply voltage
14	Inwh	I	W-phase high side gate driver input
15	I _{NWL}	I	W-phase low side gate driver input
16	NC	I/O	No Connection
17	Р	I/O	Positive bus input voltage
18	U,V _{SU}	0	Motor U-phase output and U-phase high side
			drive bias voltage ground
19	NU	I/O	U-phase low side source
20	NV	I/O	V-phase low side source
21	V,V _{SV}	0	Motor V-phase output and V-phase high side
			drive bias voltage ground
22	NW	I/O	W-phase low side source
23	W,Vsw	0	Motor W-phase output and W-phase high side
			drive bias voltage ground

Function description

Input-output table

INH	INL	OUTPUT	REMARK
0	0	Z	The high and low sides of the bridge arm are closed
0	1	0	The low side of the bridge arm is opened
1	0	VDC	The high side of the bridge arm is opened
1	1	Forbid	Bridge arm punch through
Open	Open	Z	The high and low sides of the bridge arm are closed

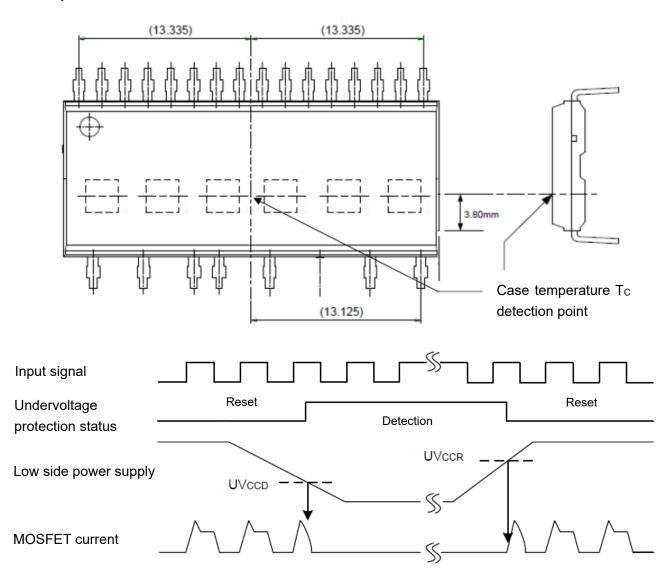




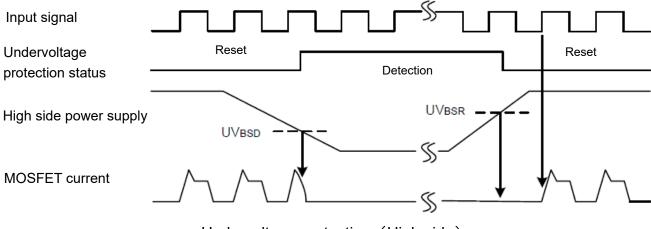
Temperature Profile of VTS(Typical)

I_D Drain Current vs. Case Temperature

Case temperature Tc detection

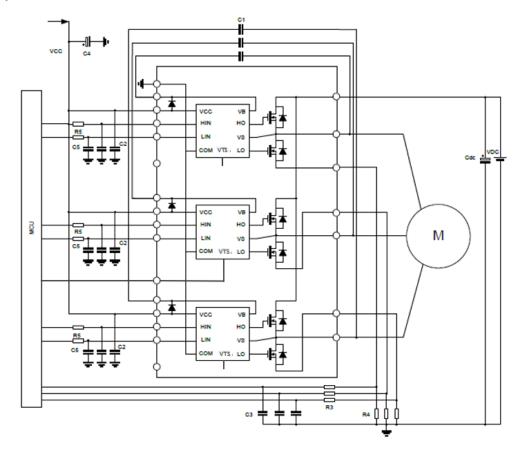


Undervoltage protection (Low side)



Undervoltage protection (High side)

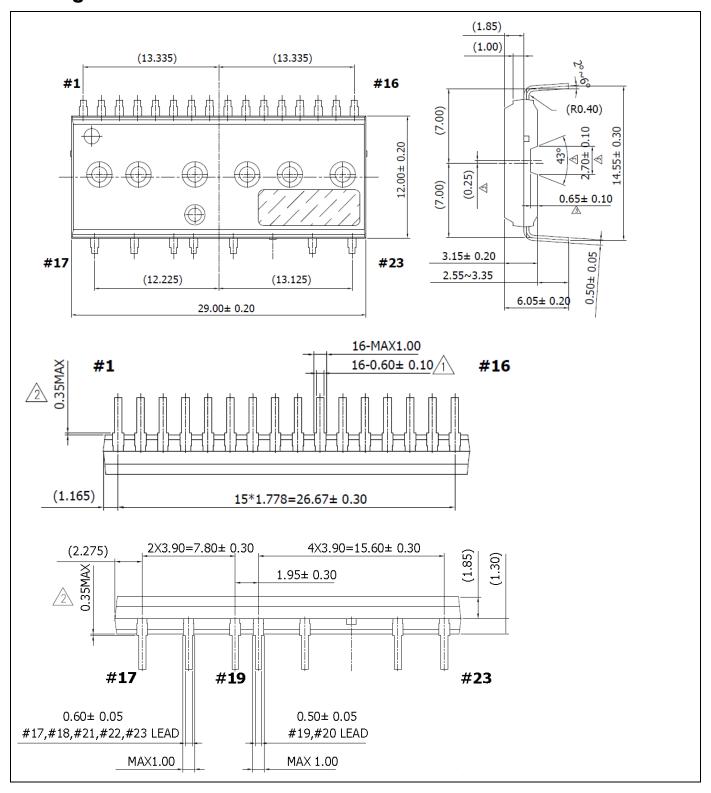
Typical Application Schematic:



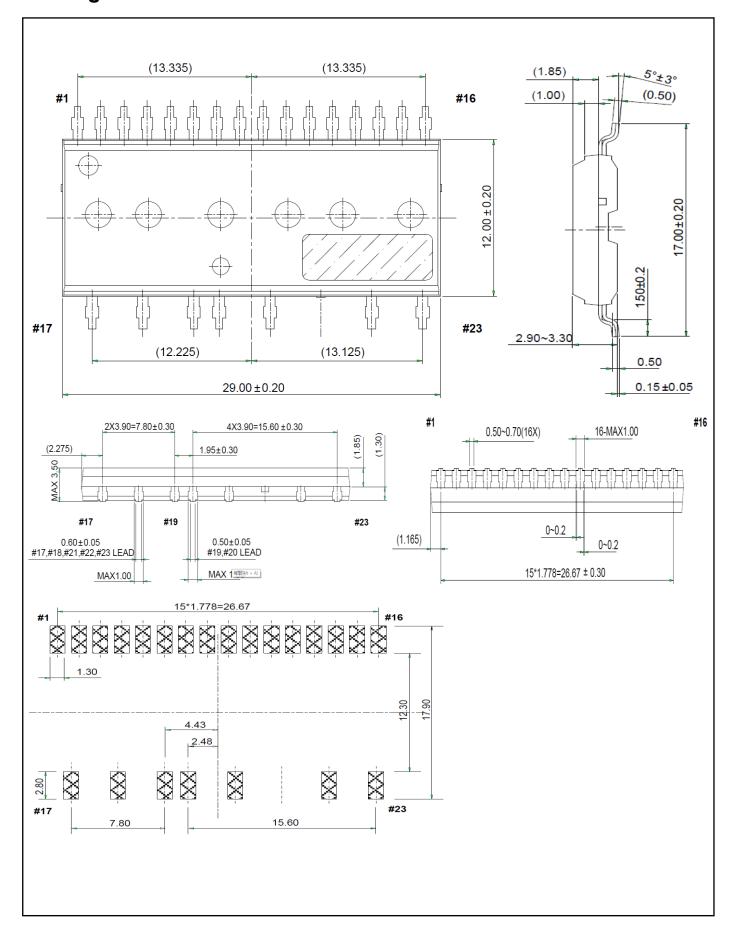
Remark:

- (1) The wiring of each input pin shall be as short as possible, otherwise it may cause mis operation; in addition, RC filter can be used to reduce input signal noise.
- (2) All external capacitors should be located close to IPM.
- (3) In order to prevent surge damage, in addition to filter capacitance between PN, it is recommended to add a high-frequency non inductive smoothing capacitance, and the connection of capacitance should be as short as possible.
- (4) The filter capacitance at the input of VCC power supply is recommended to be at least 7 times of bootstrap capacitance C1.
- (5) The bootstrap capacitor C1 is suggested to adopt a capacitor with high frequency characteristics to absorb high frequency ripple current, and its capacitance value is suggested to be greater than 2.2uf.
- (6) The connection between current limiting resistor R4 and IPM shall be as short as possible to prevent the large surge voltage generated by the connection inductance from damaging IPM.

Package Outline DIP23



Package Outline SOP23



Disclaimer:

Operating conditions may differ from simulation assumptions in several aspects like level of DC-link voltage, applied gate-voltage and gate-resistor, case and junction temperatures as well as the power circuit stray-inductance. Therefore, deviations of parameters and assumptions used for the simulation and the real application may exist.

For these reasons we cannot take any responsibility or liability for the exactness or validity of the form's results. The form cannot replace a detailed reflection of the customers application with all of its operating conditions.

Accurate results depend on huge data, so with the measured data is increasing, we should be updated in real time and send it to the corresponding engineer so that he can know it in real time.